

September 2009

# **RB520S30 Schottky Barrier Diodes**

### **Features**

- Low Forward Voltage Drop
- Flat Lead, Surface Mount Device Under 0.70mm Height
- Extremely Small Outline Plastic Package SOD523F
- Moisture Level Sensitivity 1
- · Pb-free Version and RoHS Compliant
- · Matte Tin (Sn) Lead Finish
- · Green Mold Compound





Band Indicates Cathode RB520S30 Marking: 1B

# **Absolute Maximum Ratings \*** $T_A=25$ °C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	30	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA	
TJ	Operating Junction Temperature Range	-55 to +125	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to +125	°C	

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

## **Thermal Characteristics**

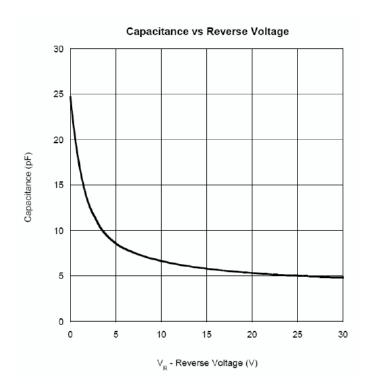
Symbol	Parameter	Value	Units
P <sub>D</sub>	Total Device Dissipation (T <sub>C</sub> =25°C)	200	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	°C/W

<sup>\*</sup> Device mounted on FR-4 PCB minimum land pad.

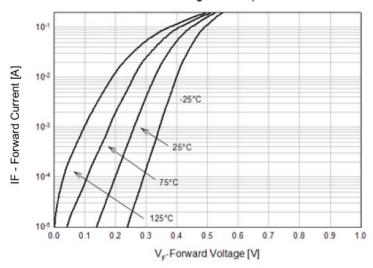
## $\textbf{Electrical Characteristics} \quad \textbf{T}_{A}\text{=-}25^{\circ}\text{C unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> =500μA	30			V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> =10V			1	μΑ
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =200mA			0.6	٧

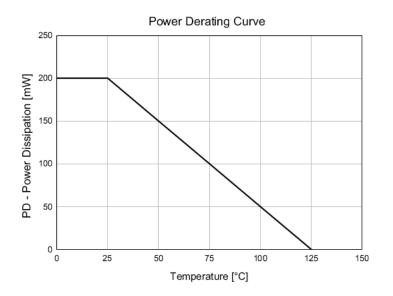
## **Typical Performance Characteristics**

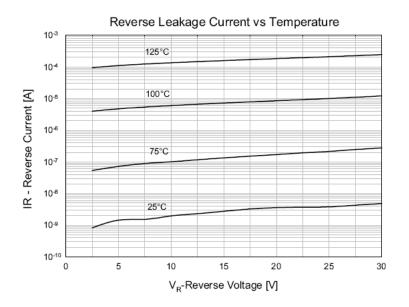


## Forward Voltage vs Temperature



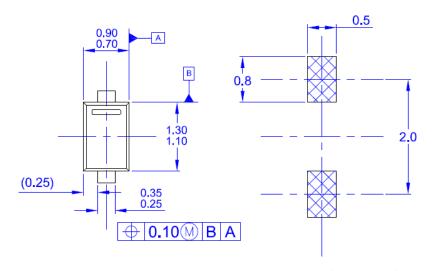
# **Typical Performance Characteristics** (Continue)



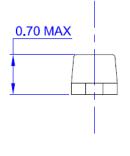


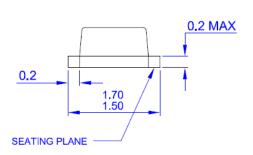
## **Physical Dimension**

## **SOD-523F**



LAND PATTERN RECOMMENDATION





## NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE REFERENCE: THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

- C) DRAWING CONFORMS TO ASME Y14,5M 1994
  D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M,
- F) DRAWING NUMBER AND REVISION:MKT-SOD523F1rev1





The Power Franchise®

puwer

TinyBoost™

TinyBuck™

TinyCalc™

TinyLogic<sup>®</sup>

TINYOPTO™

TinyPower™

TinyPWM™

TinyWire™

μSerDes™

TriFault Detect™

TRUECURRENT™\*

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

CorePLUS™ Global Power Resource<sup>SM</sup>

CorePOWER™ Green FPS™

 $\begin{array}{ll} \textit{CROSSVOLT}^{\text{\tiny TM}} & \textit{Green FPS}^{\text{\tiny TM}} \; \textit{e-Series}^{\text{\tiny TM}} \\ \textit{CTL}^{\text{\tiny TM}} & \textit{Gmax}^{\text{\tiny TM}} \end{array}$ 

Current Transfer Logic™ GTO™
EcoSPARK® IntelliMAX™
EfficentMax™ ISOPLANAR™
EZSWITCH™\* MegaBuck™

MegaBuck™

MicROCOUPLER™

MicroFET™

MicroPak™

MillerDrive™

Fairchild® MotionMax™
Fairchild Semiconductor® Motion-SPM™
FACT Quiet Series™ OPTOLOGIC®
FACT® OPTOPLANAR®
FAST®

FastvCore™
FETBench™ PDP SPM™
FlashWriter®\* Power-SPM™

PowerTrench® PowerXS™ Programmable Active Droop™

QFET<sup>®</sup>
QS™
Quiet Series™

RapidConfigure™

O<sub>TM</sub>

Saving our world, 1mW/W/kW at a time™

SmartMaxTM
SMART STARTTM
SPM®
STEALTHTM
SuperFETTM
SuperSOTTM-3
SuperSOTTM-6
SuperSOTTM-8
SuperMOSTM
SyncFETTM

Sync-Lock<sup>TM</sup>
Sync-Lock<sup>TM</sup>
SYSTEM ®\*

SerDes"
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
XS™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

### **Definition of Terms**

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. I41

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.